Special Issue

Progress in 3D Printing of Materials

Message from the Guest Editor

3D printing is rapidly emerging as a key manufacturing technique capable of serving a wide spectrum of applications, ranging from engineering to biomedical sectors. Its ability to form both simple and intricate shapes through computer-controlled graphics enables it to create a niche in the manufacturing sector. Many challenges have been solved, while many challenges remain, and much research is still required to develop 3D printing technology for all classes of materials including polymers, metals, ceramics, and composites. In view of the growing importance and acceptance of 3D manufacturing worldwide, we are launching this Special Issue, aiming to seek original articles to further assist in the development of this promising technology from both scientific and technological perspectives. Targeted reviews including mini-reviews are also welcome, as they play a crucial role in educating students and young researchers.

Guest Editor

Prof. Dr. Manoj Gupta

Department of Mechanical Engineering, National University of Singapore, Singapore 117576, Singapore

Deadline for manuscript submissions

closed (30 June 2023)



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Message from the Editor-in-Chief

As the world of science becomes ever more specialized, researchers may lose themselves in the deep forest of the ever increasing number of subfields being created. This open access journal *Applied Sciences* has been started to link these subfields, so researchers can cut through the forest and see the surrounding, or quite distant fields and subfields to help develop his/her own research even further with the aid of this multi-dimensional network.

Editor-in-Chief

Prof. Dr. Giulio Nicola Cerullo

Dipartimento di Fisica, Politecnico di Milano, Piazza L. da Vinci 32, 20133 Milano, Italy

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